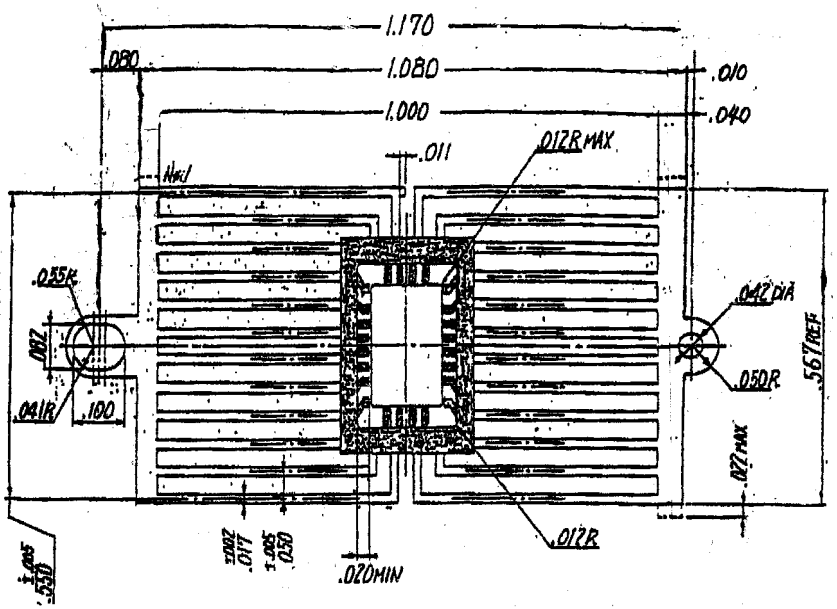
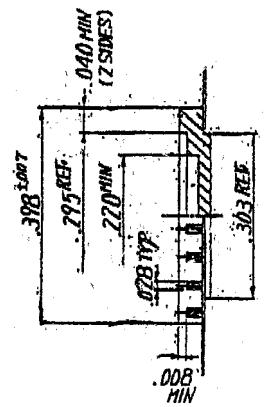
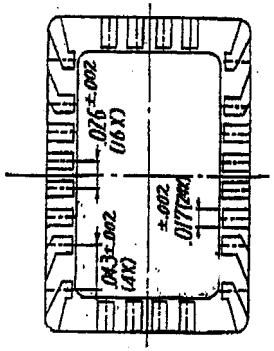
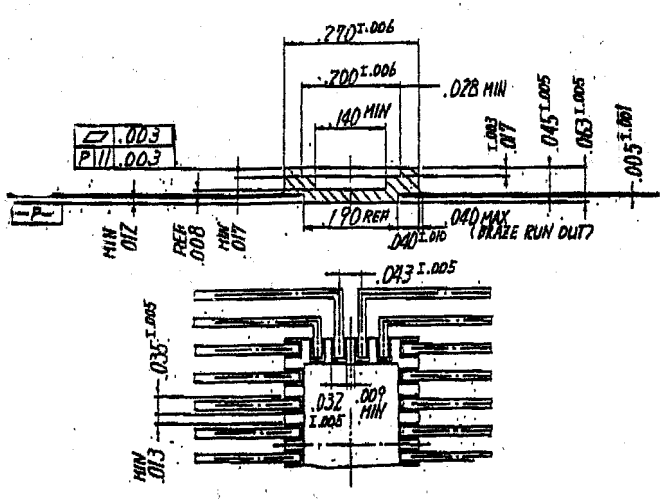
SSM P/N CCF02414









NOTES: 1 PLATE: ALL EXPOSED METALS (INCLUDING METALLIZATION) WITH 70μ INCHES MIN NICKEL AND THEN WITH 60μ INCHES MIN TO 150μ INCHES MAX THICK GOLD

2 NO LEAD SHALL BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD AND SEAL RING

OPEN-TOOLED

Item	Name	Material	Description
2	LEAD	KOVAR	
1	CERAMIC	92% WHITE ALUMINA	

Rev.	Description	Date
B	CHANGED DWG No. IFS24F1-122JB WAS -122JA	JAN-9-'88
A	RE DRAWING	JUN-15-85

UNLESS OTHERWISE SPECIFIED TOLERANCES: ± 1%
N. L. T. 2 DECIMALS .XX ±.01
3 DECIMALS .XXX ±.005

CUSTOMER

DRAWN T. Mimo
CHECKED
APPROVED
UNIT INCH
SCALE

NTK TECHNICAL CERAMICS
NGK SPARK PLUG CO., LTD

TITLE 24 LEAD FLAT PACKAGE

DWG NO. IFS24F1-122JB

SIZE A-3

SPECTRUM SEMICONDUCTOR MATERIALS, INC.
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